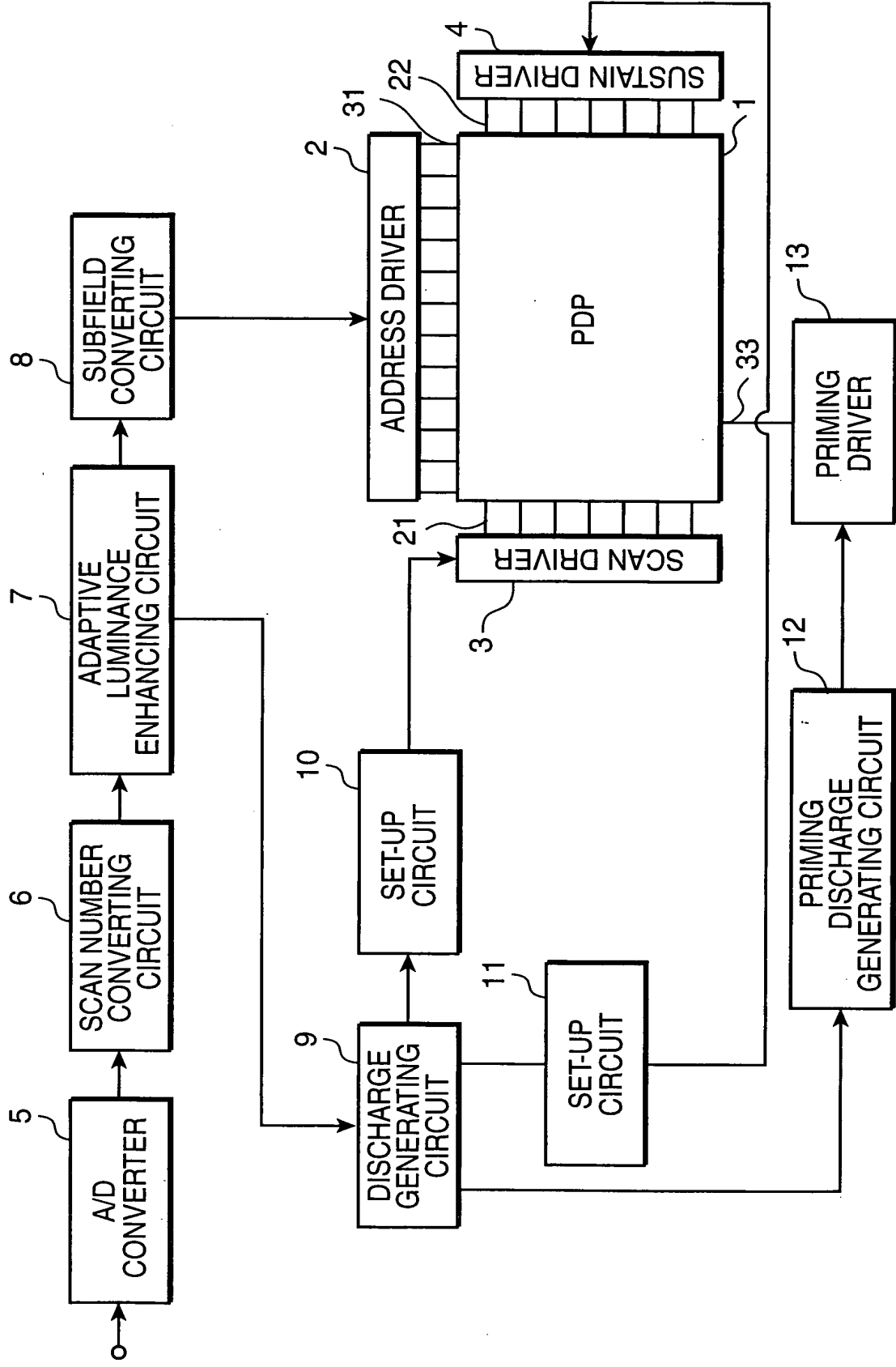


FIG.1



A detailed cross-sectional view of a multi-layered structure, likely a semiconductor device or a specialized material stack. The structure consists of several distinct layers and internal features. At the top, there is a layer labeled 23, followed by a layer 24. Below these is a layer 20, which contains a series of rectangular features labeled 22a and 22b. These features are separated by a material labeled 22. Below the 20 layer is a layer 42, which contains a series of rectangular features labeled 22b and 22a. These features are separated by a material labeled 21. Below the 42 layer is a layer 36, which contains a series of rectangular features labeled 21a and 21b. These features are separated by a material labeled 21. Below the 36 layer is a layer 35, which contains a series of rectangular features labeled 21a and 22a. These features are separated by a material labeled 22. Below the 35 layer is a layer 34, which contains a series of rectangular features labeled 21a and 22a. These features are separated by a material labeled 22. Below the 34 layer is a layer 32, which contains a series of rectangular features labeled 21a and 22a. These features are separated by a material labeled 22. Below the 32 layer is a layer 31, which contains a series of rectangular features labeled 21a and 22a. These features are separated by a material labeled 22. Below the 31 layer is a layer 36, which contains a series of rectangular features labeled 21a and 22a. These features are separated by a material labeled 22. Below the 36 layer is a layer 33, which contains a series of rectangular features labeled 21a and 22a. These features are separated by a material labeled 22. Below the 33 layer is a layer 42, which contains a series of rectangular features labeled 21a and 22a. These features are separated by a material labeled 22. Below the 42 layer is a layer 41, which contains a series of rectangular features labeled 21a and 22a. These features are separated by a material labeled 22. Below the 41 layer is a layer 36, which contains a series of rectangular features labeled 21a and 22a. These features are separated by a material labeled 22. Below the 36 layer is a layer 30, which contains a series of rectangular features labeled 21a and 22a. These features are separated by a material labeled 22. The entire structure is shown in a cross-sectional view, with various layers and features labeled with numbers.

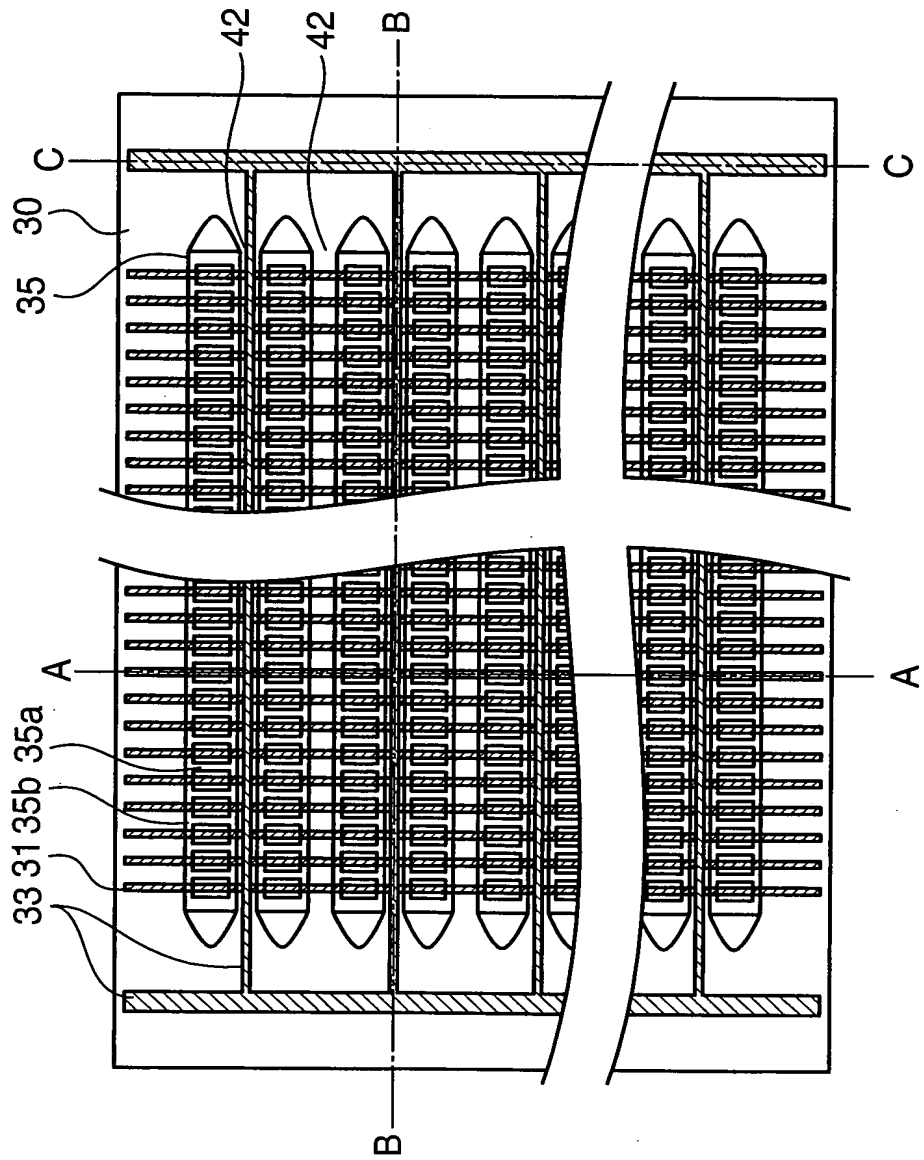


FIG.5

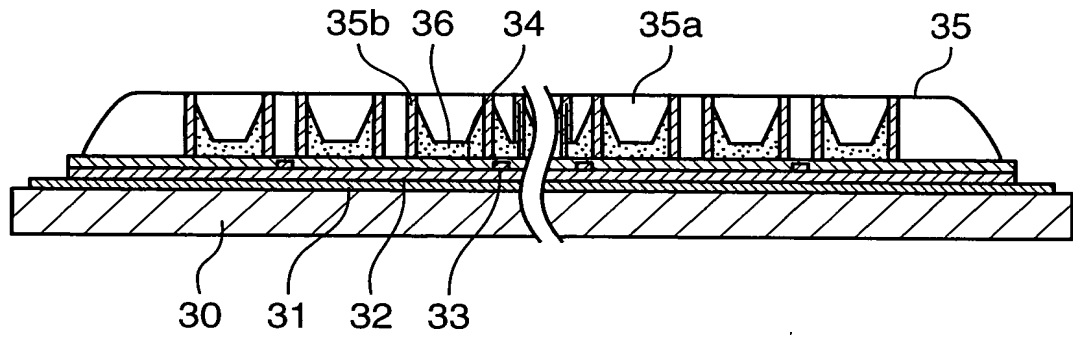


FIG.6

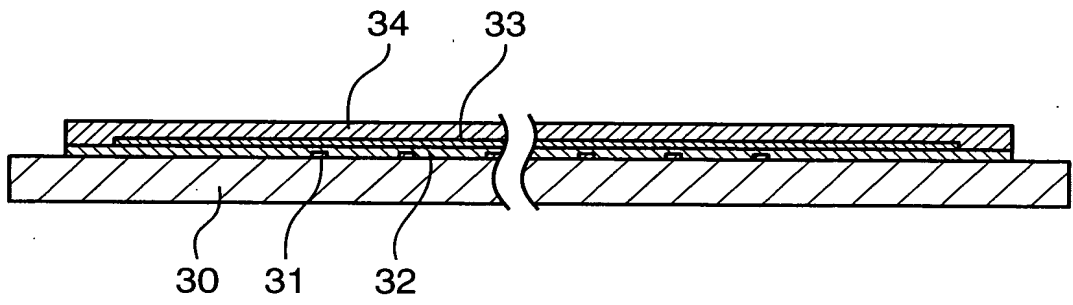


FIG.7

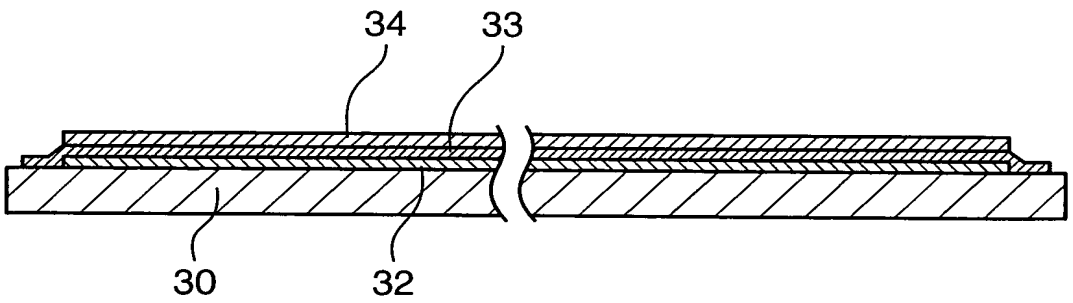


FIG.8

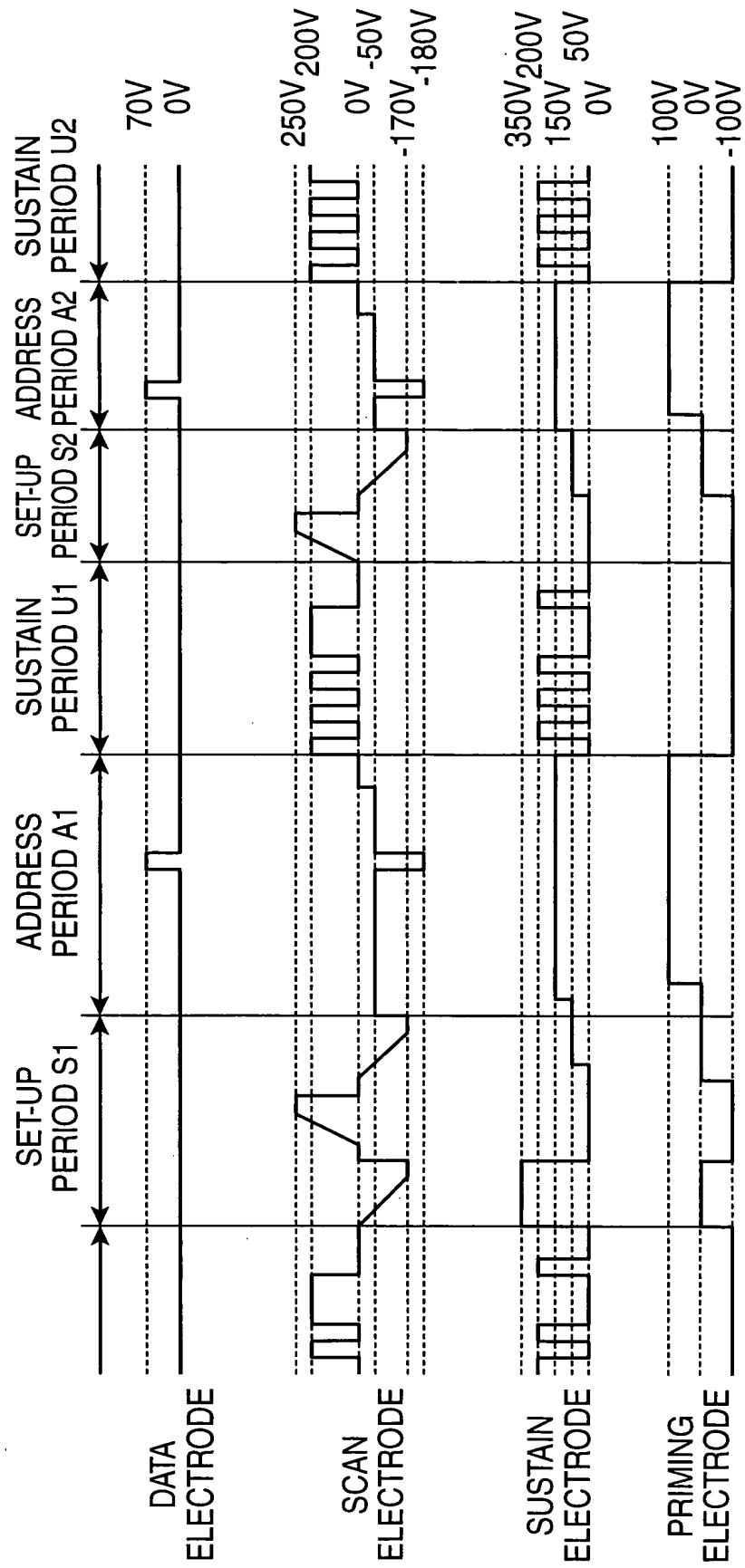


FIG.9

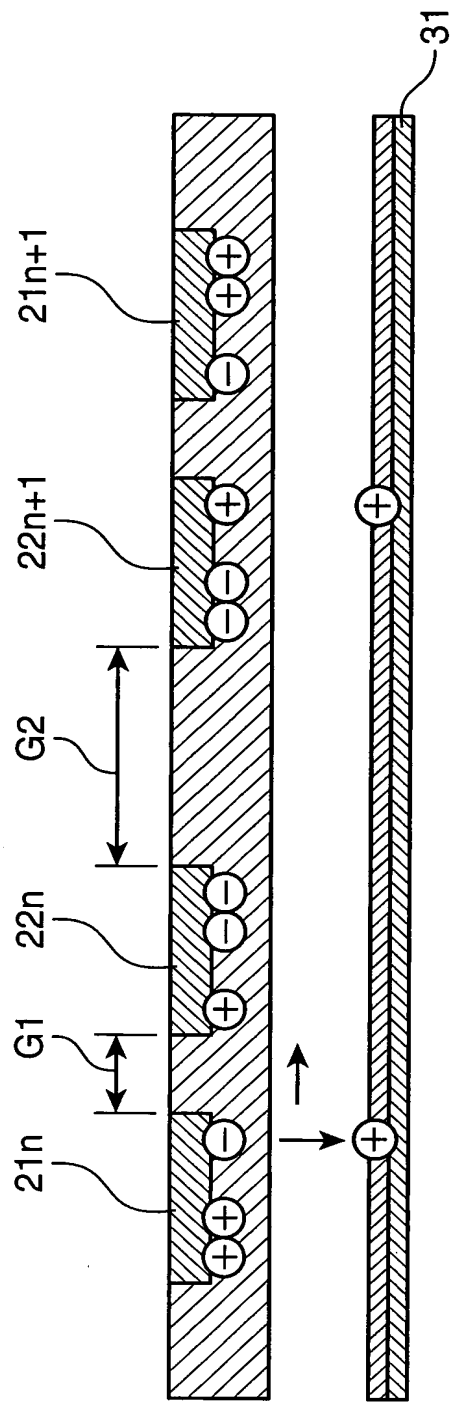


FIG.10

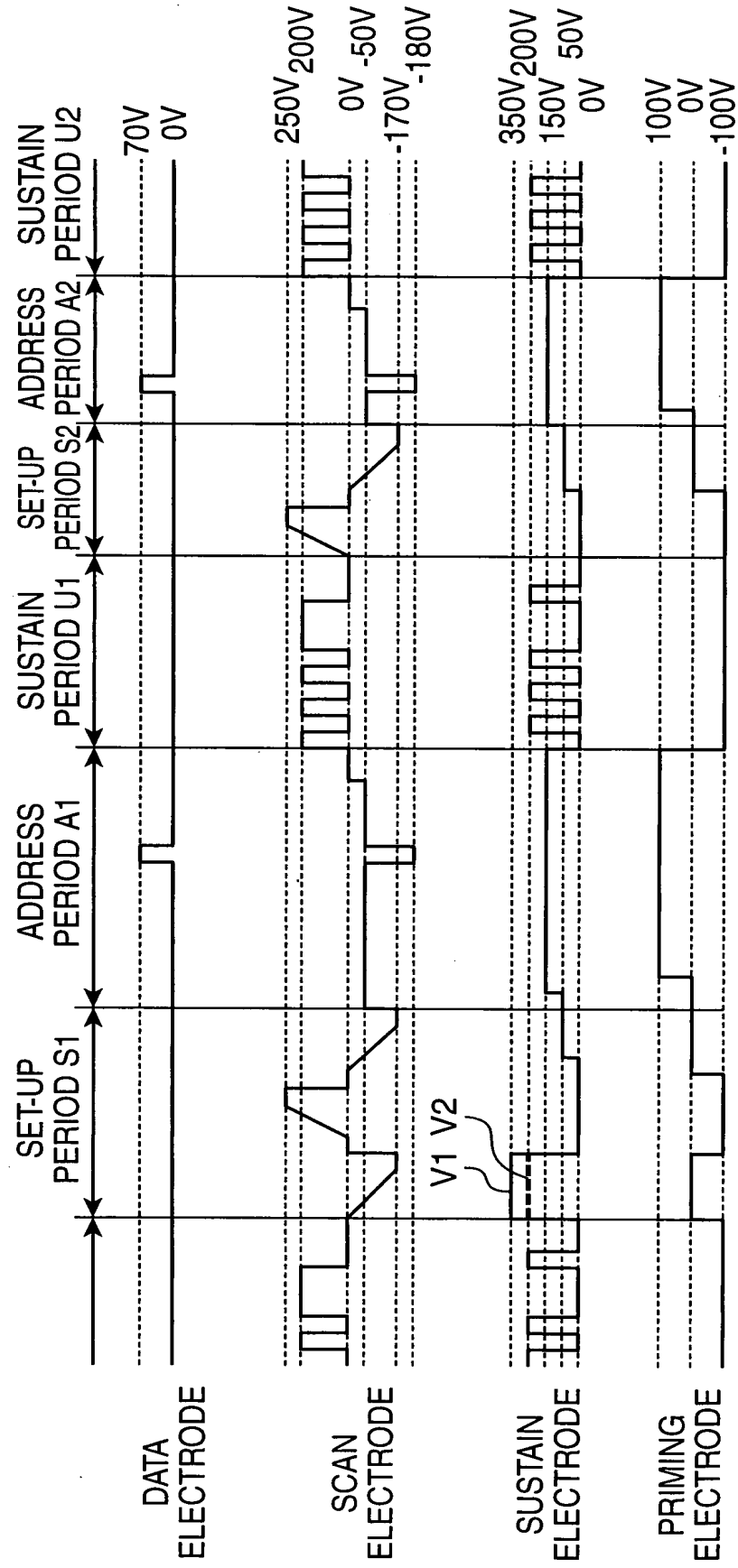


FIG.11

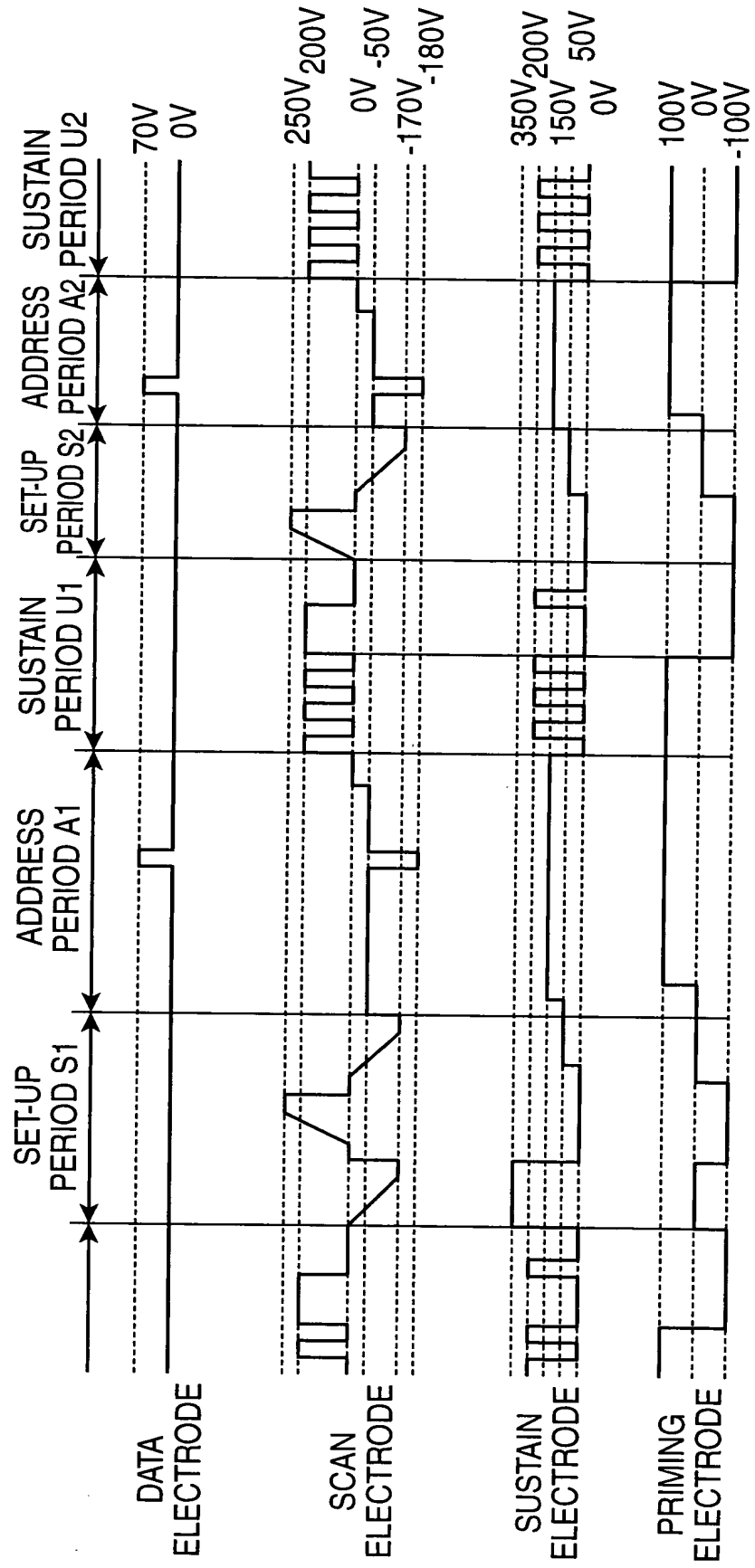




FIG.12

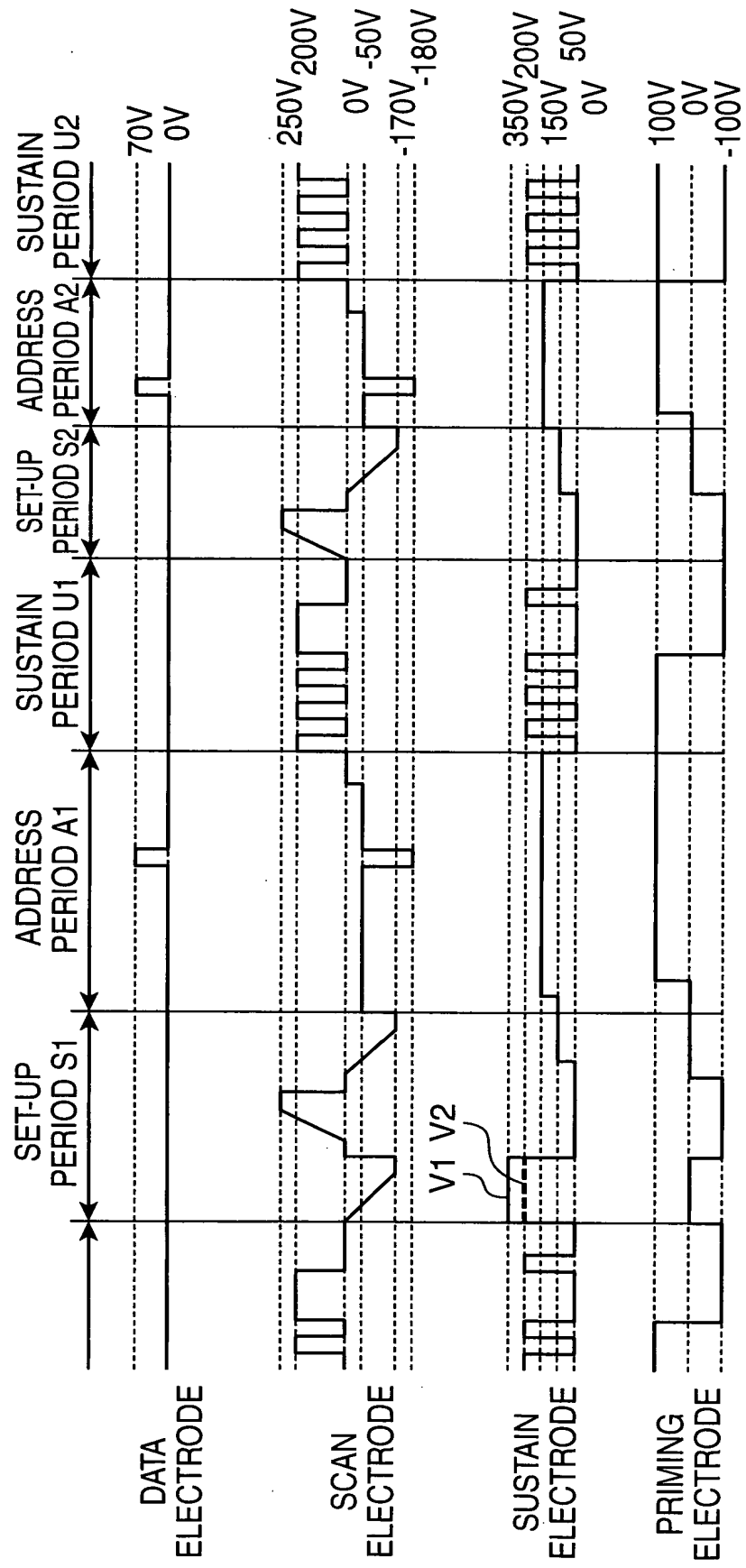


FIG.13

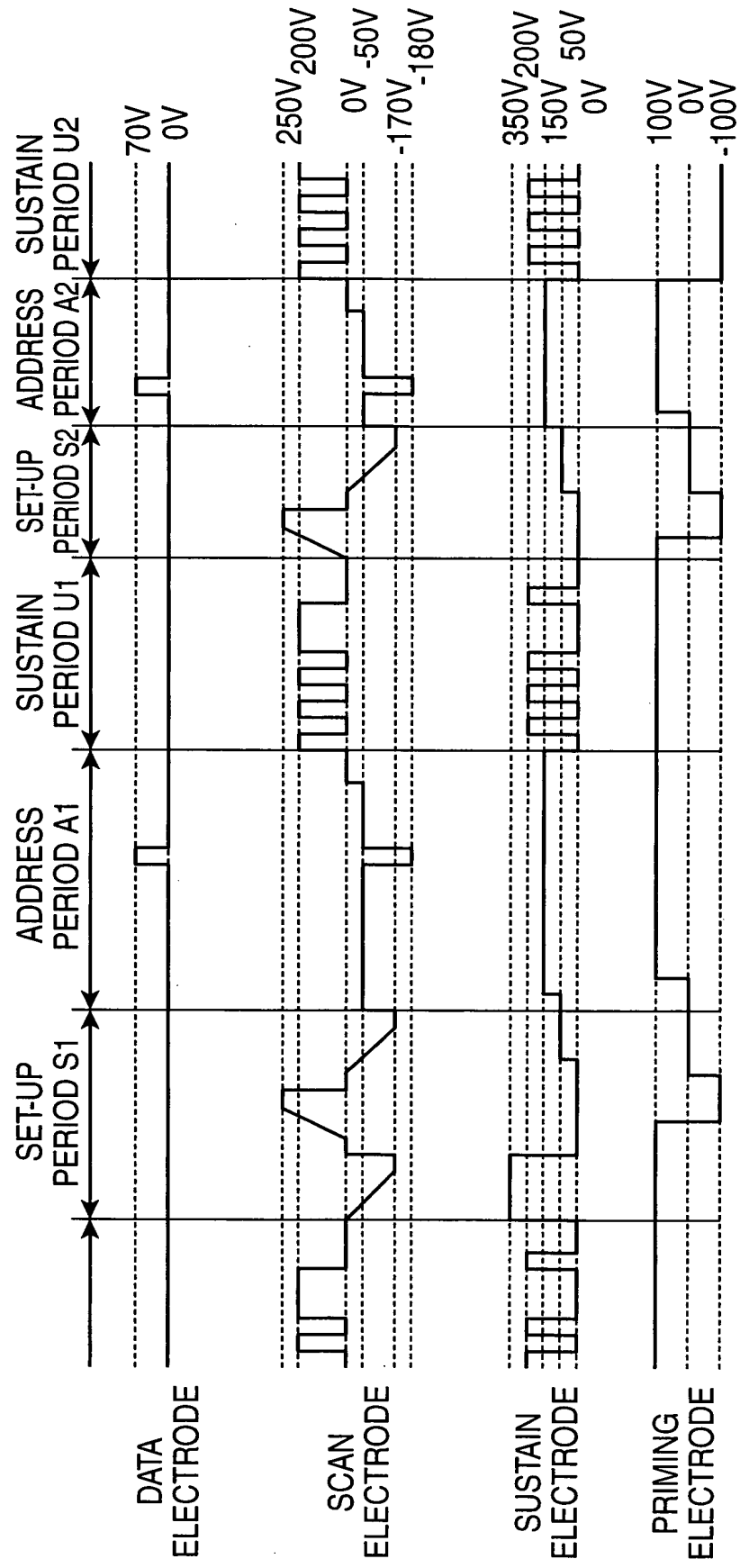


FIG.14

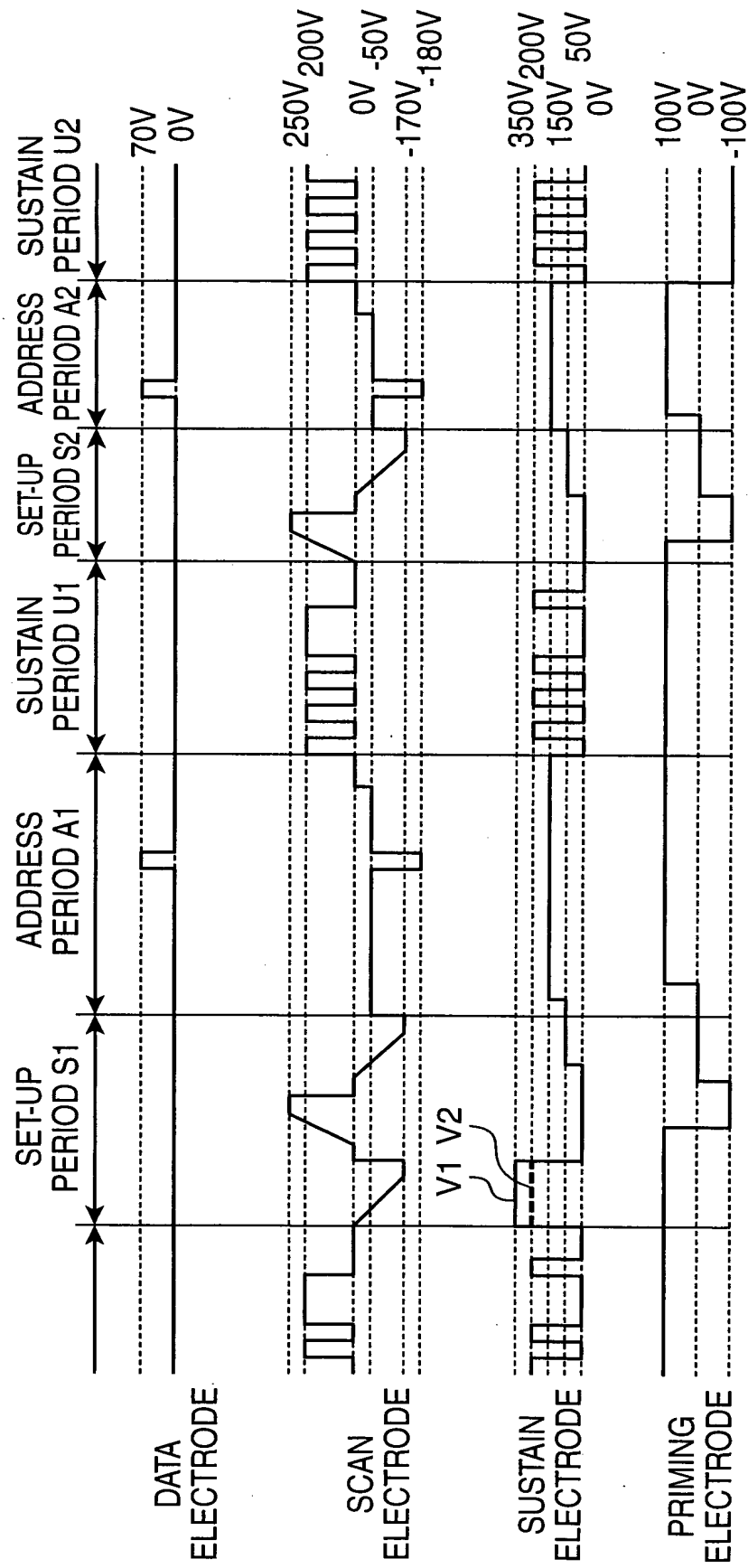


FIG.15

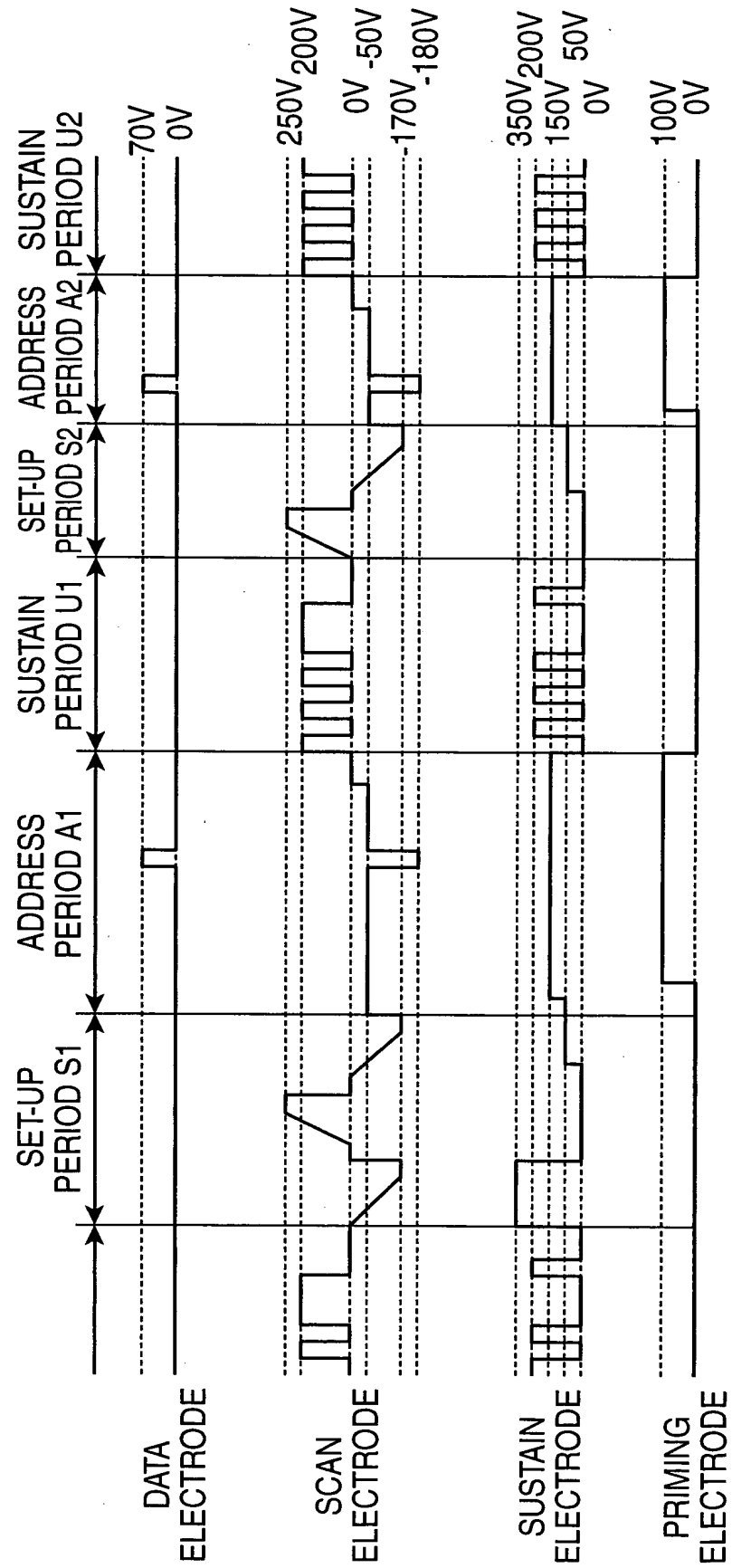


FIG.16

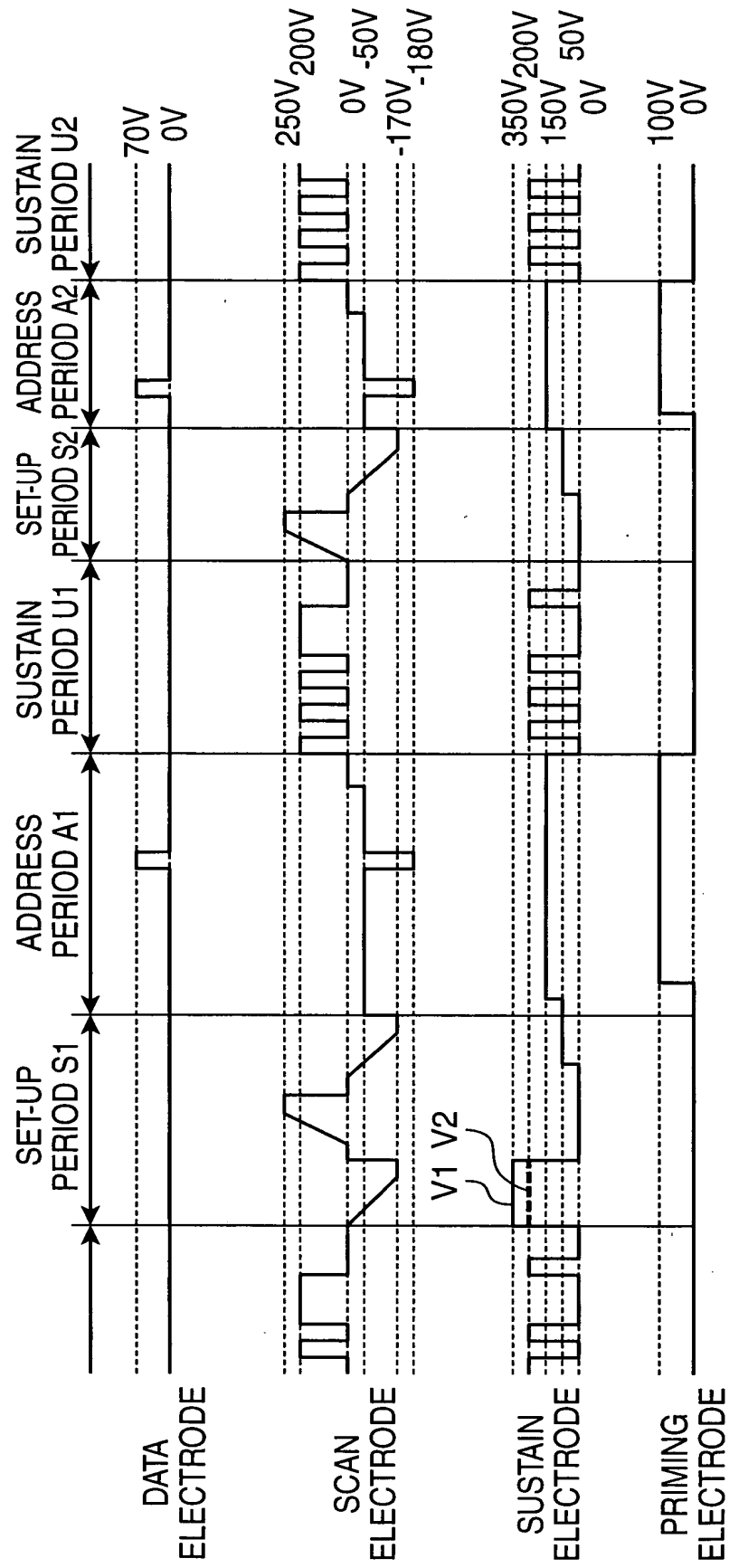


FIG.17

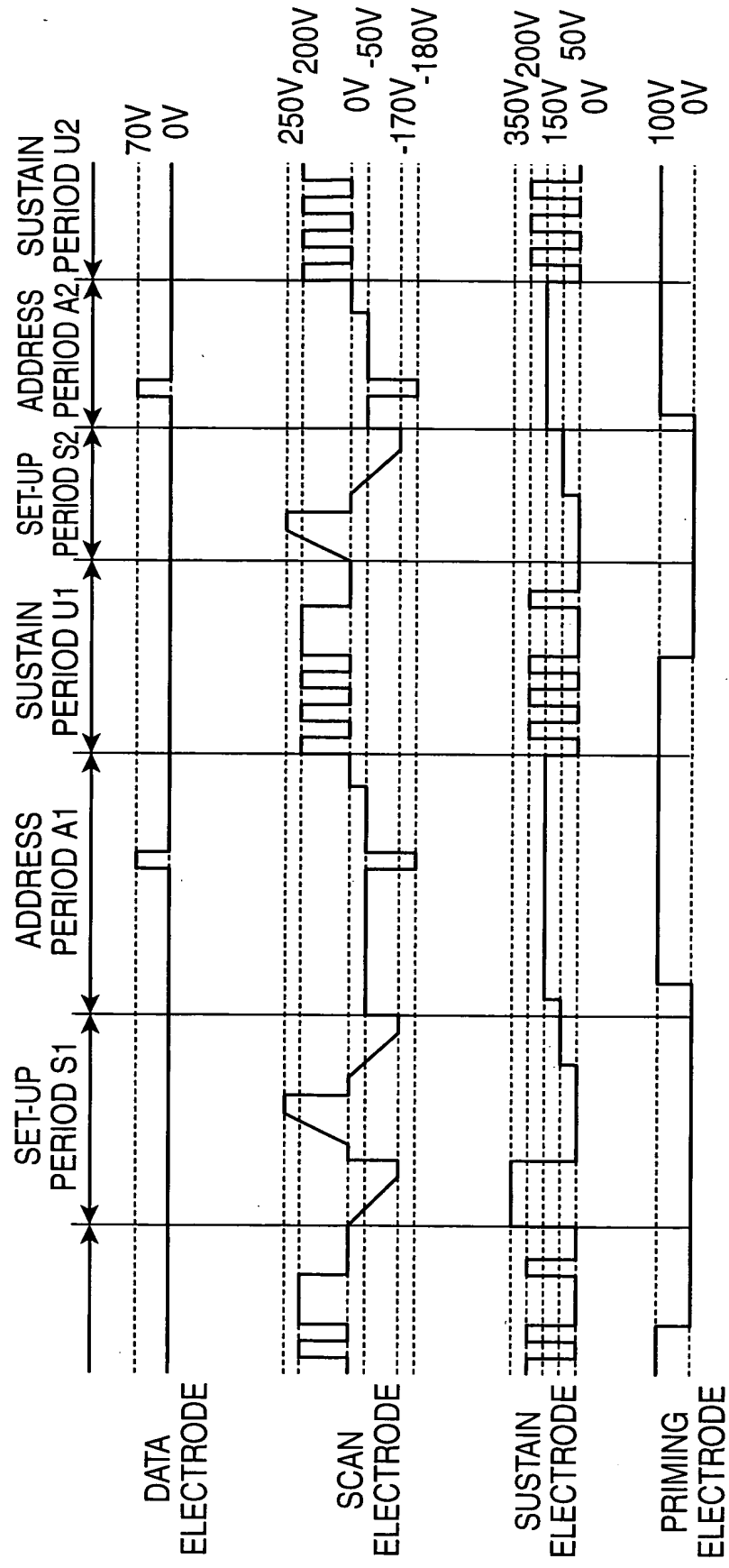


FIG.18

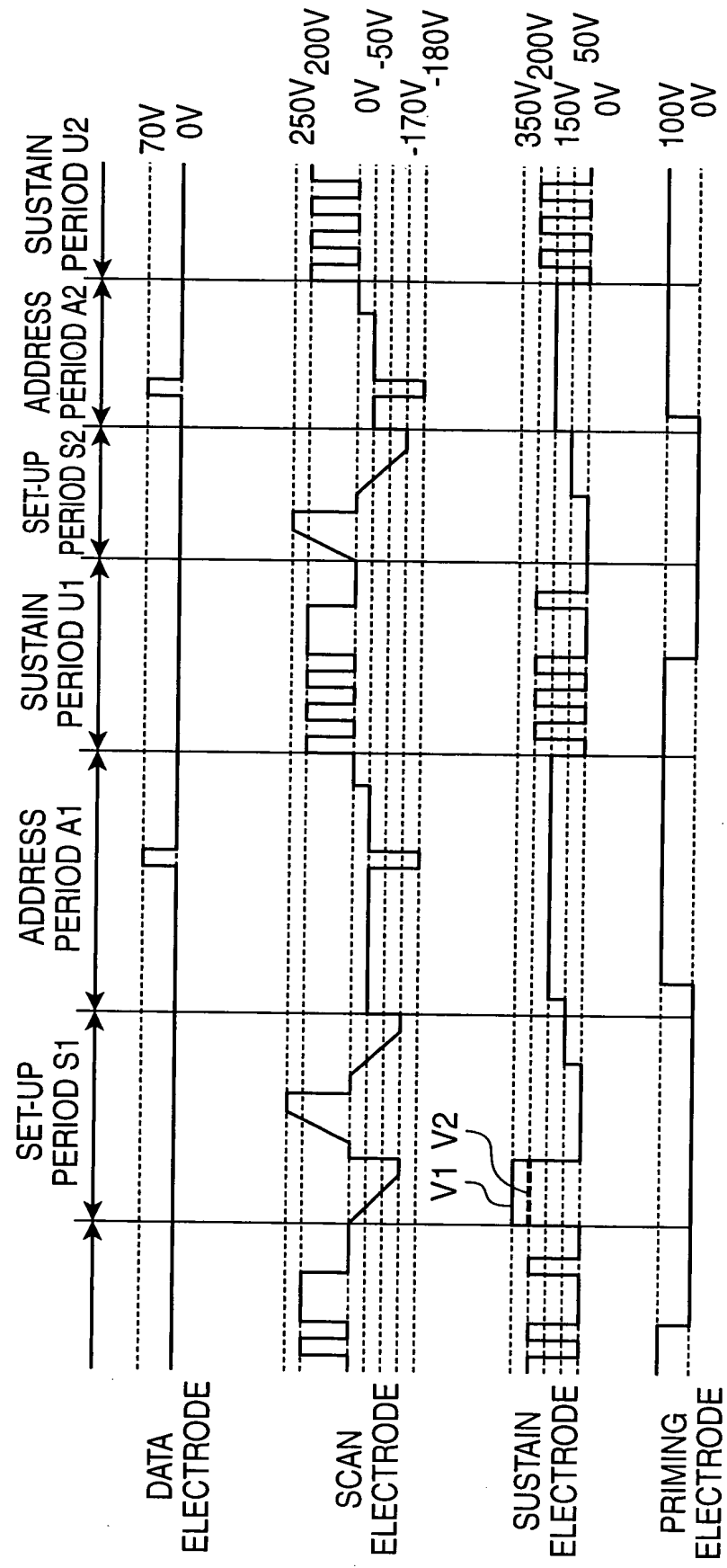


FIG.19

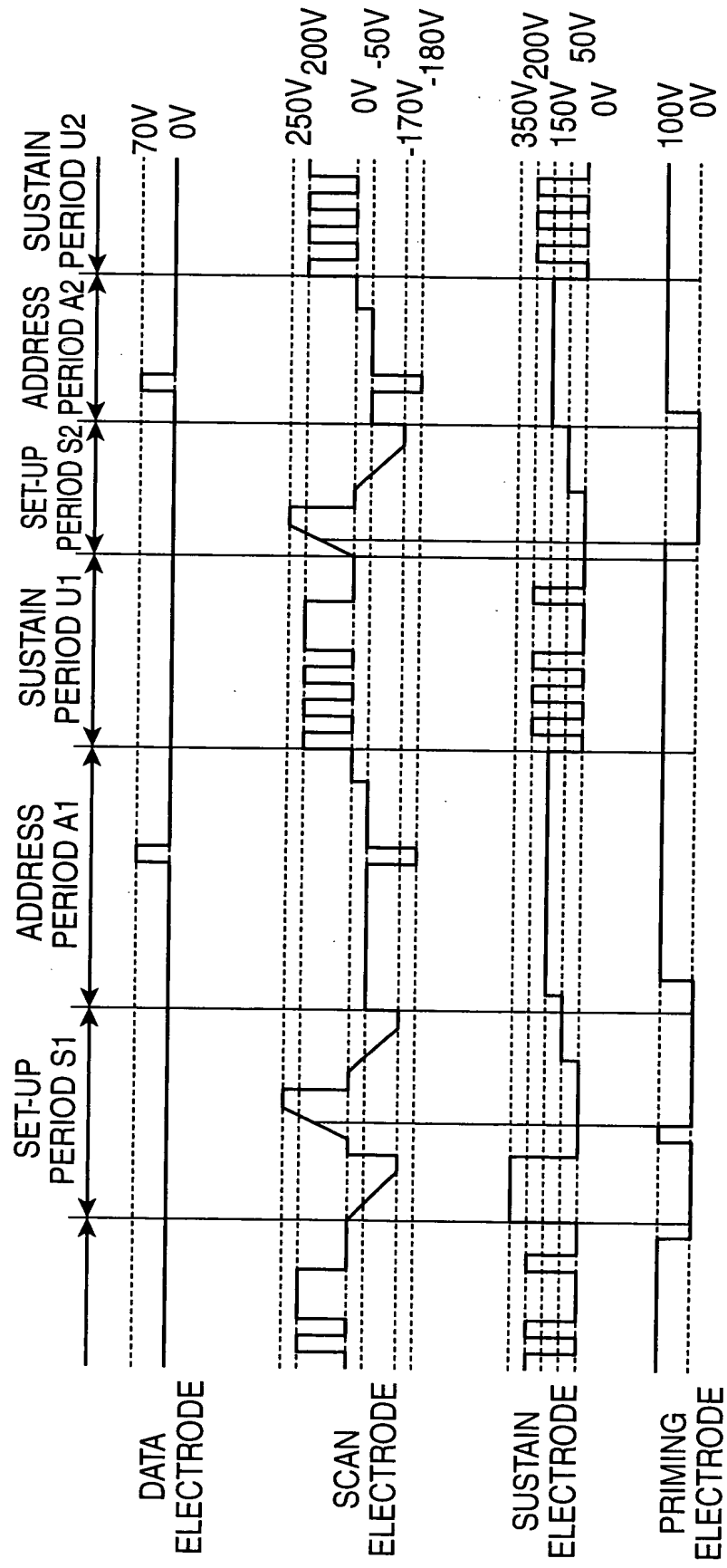




FIG.20

